

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

Notification# 20220511003.0 Datasheet for CDx4HC373, SNx4HC241, SNx4HC541, SNx4HC574 and SNx4HC377 Information Only

Date: May 19, 2022

To: TOKYO ELECTRON DEVICE (DSTR) PCN

Dear Customer:

This is an information-only announcement of a change to the datasheet for a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN team (PCN www admin team@list.ti.com).

Sincerely,

PCN Team SC Business Services

Information Only Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
SN74HC377NSR	null
SN74HC541N	null
SN74HC541DW	null
SN74HC541NS	null
SN74HC541PWR	null
SN74HC541PWT	null
SN74HC574NS	null
SN74HC541NSR	null
SN74HC541PW	null
SN74HC574PW	null
SN74HC241PWR	null
SN74HC574PWR	null
SN74HC241NSR	null
SN74HC574NSR	null

Technical details of this Product Change follow on the next page(s).

	Notification		
	73, SNx4HC241, SNx4HC541		
ustomer Contact: PCN Manag	<u>jer</u>	Dept: Quality Se	rvices
hange Type:			
Assembly Site	Design	Wafer Bump Site	
Assembly Process	□ Data Sheet	Wafer Bump Mate	
Assembly Materials	Part number change	Wafer Bump Proc	ess
Mechanical Specification	Test Site	Wafer Fab Site	
Packing/Shipping/Labeling	Test Process	Wafer Fab Materi	als
		■ Wafer Fab Proces	S
	Notification Details		
escription of Change:			
exas Instruments Incorporated is ne product datasheet(s) is being une following change history provid	updated as summarized belo		
TEXAS INSTRUMENTS		CD54HC373, C SCLS452C – FEBRUARY 2001 – REVIS	
Changes from Povision P / January 26	122) to Pavision C (May 2022)		Page
 Changes from Revision B (January 20 Junction-to-ambient thermal resistance 		400 4 Ni 00 is	Page
NS was 60 is now 113.4, PW was 83	75 110W 101.0		
Instruments		SN54HC541, SN SCLS305E – JANUARY 1996 – REVISE	
Changes from Revision D (September		•	Page
 Updated ESD ratings table to include Junction-to-ambient thermal resistand 109.1, N was 45.2 is now 84.6, NS w 	ce values increased. DB was 90.2	2 is now 122.7, DW was 77.5 is	s now
TEXAS INSTRUMENTS		SN54HC574, SN SCLS148H – DECEMBER 1982 – REVISE	
Changes from Revision G (December	2021) to Revision H (May 2022)		Page
Junction-to-ambient thermal resistand N was 69 is now 84.6, NS was 60 is it.	ce values increased. DW was 58 is	s now 109.1, DB was 70 is now	и 122.7,
W		SN54HC377, SN	
TEXAS INSTRUMENTS		SCLS307D - JANUARY 1996 - REVISE	
	2022) to Revision D (May 2022)	SCLS307D – JANUARY 1996 – REVISE	

The datasheet number will be changing.

Device Family	Change From:	Change To:
CDx4HC373	SCLS452B	SCLS452C
SNx4HC241	SCLS300D	SCLS300E
SNx4HC541	SCLS305D	SCLS305E
SNx4HC574	SCLS148G	SCLS148H
SNx4HC377	SCLS307C	SCLS307D

These changes may be reviewed at the datasheet links provided.

http://www.ti.com/product/CD54HC373

http://www.ti.com/product/SN54HC241

http://www.ti.com/product/SN54HC541

http://www.ti.com/product/SNx4HC574

http://www.ti.com/product/SNx4HC377

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Reason for Change:

To accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this notification:

None.

Product Affected:

CD74HC373E	SN74HC241PWG4	SN74HC541DWR	SN74HC574DW
CD74HC373EE4	SN74HC241PWR	SN74HC541N	SN74HC574DWG4
CD74HC373M	SN74HC241PWRE4	SN74HC541NE4	SN74HC574DWR
CD74HC373M96	SN74HC377DW	SN74HC541NS	SN74HC574N
CD74HC373ME4	SN74HC377DWR	SN74HC541NSR	SN74HC574NE4
SN74HC241DW	SN74HC377N	SN74HC541PW	SN74HC574NS
SN74HC241DWE4	SN74HC377NE4	SN74HC541PWG4	SN74HC574NSR
SN74HC241DWR	SN74HC377NSR	SN74HC541PWR	SN74HC574PW
SN74HC241DWRG4	SN74HC541DBR	SN74HC541PWT	SN74HC574PWR
SN74HC241N	SN74HC541DW	SN74HC574APWR	SN74HC574PWRE4
SN74HC241NSR	SN74HC541DWE4	SN74HC574DBR	SN74HC574PWRG4
SN74HC241PW	SN74HC541DWG4	SN74HC574DBRG4	SN74HC574PWT

For questions regarding this notice, e-mails can be sent to the contact shown below or your local Field Sales Representative.

Location	E-Mail
WW PCN Team	PCN www admin team@list.ti.com

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